# 1971032-8 ACTIVE

### **GRACE INERTIA 2.0**

TE Internal #: 1971032-8

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2 mm [.079] in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE

INERTIA 2.0

View on TE.com >



### Connectors > PCB Connectors > PCB Headers & Receptacles











Connector System: Wire-to-Board

Number of Positions: 8 Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in] PCB Mount Orientation: Vertical

## **Features**

## **Product Type Features**

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	8
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	
Primary Product Color	Natural



## **Contact Features**

Contact Mating Area Length	3 mm[.118 in]
Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	2 μm[78.73 μin]
Contact Layout	Inline
Contact Underplating Material Thickness	1 μm[39.37 μin]
Contact Mating Area Plating Material Thickness	2 μm[78.73 μin]
PCB Contact Termination Area Plating Material Finish	Bright
Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Tab
Contact Current Rating (Max)	2.2 A

## **Termination Features**

Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	2.6 mm[.102 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

## Mechanical Attachment

Mating Alignment TypeKeyedMating RetentionWithPanel Mount FeatureWithoutMating Retention TypeLatchConnector Mounting TypeBoard MountMating AlignmentWithPCB Mount AlignmentWithPCB Mount RetentionWithout	PCB Mount Alignment Type	Locating Posts
Panel Mount Feature  Mating Retention Type  Latch  Connector Mounting Type  Board Mount  Mating Alignment  With  PCB Mount Alignment  With	Mating Alignment Type	Keyed
Mating Retention Type  Connector Mounting Type  Board Mount  Mating Alignment  With  PCB Mount Alignment  With	Mating Retention	With
Connector Mounting Type  Board Mount  Mating Alignment  With  PCB Mount Alignment  With	Panel Mount Feature	Without
Mating Alignment  PCB Mount Alignment  With  With	Mating Retention Type	Latch
PCB Mount Alignment With	Connector Mounting Type	Board Mount
	Mating Alignment	With
PCB Mount Retention Without	PCB Mount Alignment	With
	PCB Mount Retention	Without

## **Housing Features**

Housing Material	Nylon 66 GF
Centerline (Pitch)	2 mm[.079 in]

## Dimensions



Connector Length	20 mm[.78 in]
Connector Height	6.5 mm[.255 in]
Connector Width	5.6 mm[.22 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	UL
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	200
Packaging Type	Package

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits



as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



TE Part # 1971032-4 4POS HEADER ASSEMBLY FOR GIC 2.0 EV



TE Part # 1971032-3
3P HEADER ASSEMBLY FOR GIC 2.0
EV



TE Part # 1971032-5
5P HEADER ASSEMBLY FOR GIC 2.0
EV



TE Part # 1971032-7 7pos header assembly for gic 2.0 ev



TE Part # 1971032-2 2POS HEADER ASSEMBLY FOR GIC 2.0 EV



TE Part # 1971032-6 6POS HEADER ASSEMBLY FOR GIC 2.0 EV



TE Part # 1971032-9

9POS HEADER ASSEMBLY FOR GIC

2.0 EV



TE Part # 1-1971032-3
3POS HEADER ASSEMBLY FOR GIC
2.0 EV



TE Part # 1-1971032-8

8POS HEADER ASSEMBLY FOR GIC

2.0 EV



TE Part # 1971032-1 10POS HEADER ASSEMBLY FOR GIC 2.0 EV

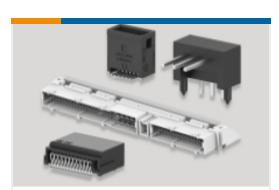


TE Part # 2-1971032-8 8POS HEADER ASSEMBLY FOR GIC 2.0 EV



TE Part # 3-1971032-8 8POS HEADER ASSEMBLY FOR GIC 2.0 EV

## Also in the Series | GRACE INERTIA 2.0



PCB Headers & Receptacles(70)



Rectangular Connector Housings(20)

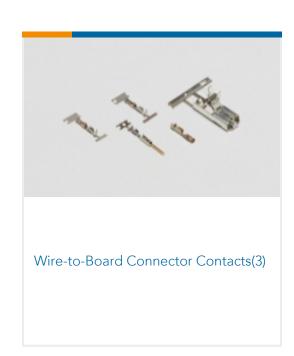


Standard Rectangular Connectors(18)



Wire-to-Board Connector Assemblies & Housings(1)





# Customers Also Bought



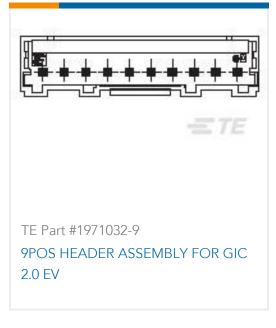














## **Documents**

**Product Drawings** 

8POS HEADER ASSEMBLY FOR GIC 2.0 EV

English

8POS HEADER ASSEMBLY FOR GIC 2.0 EV

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1971032-8\_D.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1971032-8\_D.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1971032-8\_D.3d\_stp.zip

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English

Product Environmental Compliance

MD\_1971032-8\_082020181216\_dmtec

English

MD\_1971032-8\_082020181216\_dmtec

English